



PCB LAYOUT

NOTE:

Material:

Insulator:LCP,UL94V-0

Contact:Phosphor Bronze

Finish-Contact area:10u" Au plated over Nickel

Solder tail:Tin/Lead plated over Nickel

Underplated:Nickel plated overall

Cover:Stainless Steel

Finish-Solder Tail:Au plated over Nickel

Underplated:Nickel plated overall

UNSPECIFIED TOLERANCE: .XX ± 0.25 [0.010]

.X ± 0.30 [0.012]

<h1>XMULTIPLE</h1>		CONNECTING THE INFORMATION AGE	
XMULTIPLE ASIA 4F, No. 347, Yang Guang St., Neihu Chiu, Taipei, Taiwan 11475		XMULTIPLE USA 543 Country Club Drive #B 128 Simi Valley, CA 93065	
THIS DRAWING IS A CONTROLLED DOCUMENT.		CUSTOMER/NO:	
TITLE: Memory Stick Card Connector Normal Type		DWG NO: XMSC-0-10M4-WG00-10	
PART NO: XMSC-0-10M4-WG00-10		DRAWN: TARA	
		CHKD: JEFF	
		DATE: 14/10/04	
DIMENSIONS		SHEET	REV
mm[inch]		1 of 1	01